



Product Change Notification

111287 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 111287 - 00

**Change Title: Intel® RAID Smart Battery
AXXRSBBU9, Single, PCN 111287-
00, Order Code, Product Material,
Adding RAID on Chip (ROC)
Module and Battery Backup cables
to support Romley Products**

Date of Publication: January 10, 2012

Key Characteristics of the Change:

Order Code

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Mar 02, 2012
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Description of Change to the Customer:

Intel is announcing the addition of four cables to existing Product code AXXRSBBU9. These additional cables are necessary to support RAID on Chip (ROC) Modules and Battery Backup units in next generation Romley Products.

Customer Impact of Change and Recommended Action:

Intel anticipates no customer issues, although they may wish to perform testing as needed and update documentation accordingly

Products Affected / Intel Ordering Codes:

Marketing Name	Pre Conversion Product Code	Pre Conversion MM#	Post Conversion Product Code	Post Conversion MM#
Intel® RAID Smart Battery AXXRSBBU9, Sin	AXXRSBBU9	914238	AXXRSBBU9	919738

PCN Revision History:

Date of Revision:
January 10, 2012

Revision Number:
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Reason:
Originally Published PCN